

Amendments to the Claims: This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims

1. (Currently Amended) A heat-sealable, composite film comprising a biaxially oriented polymeric substrate layer having a first and second surface, and disposed on a surface of the substrate layer a water-soluble barrier layer extending over the entire surface, wherein
 - (i) the substrate layer has one or more venting means therein; and
 - (ii) the thickness of the barrier layer is from about 0.05 to about 40 μm .
2. (Previously Presented) The film according to claim 1 wherein the thickness of the barrier layer is from about 5 to about 30 μm .
3. (Previously Presented) The film according to claim 1 wherein the barrier layer is selected from polysaccharides, polyvinyl alcohol, vinyl alcohol copolymers, polyvinylpyrrolidone and polypeptides.
4. (Previously Presented) The film according to claim 3 wherein the barrier layer is selected from chitosan, xanthan gum, cellulose derivatives, starch and starch derivatives and vinyl acetate-vinyl alcohol-polyoxyalkylene methacrylate copolymers.
5. (Previously Presented) The film according to claim 4 wherein the barrier layer is disposed on the first surface of the substrate.
6. (Previously Presented) The film according to claim 1 wherein the substrate layer is a polyolefin.
7. (Previously Presented) The film according to claim 1 wherein the substrate comprises polyester.
8. (Previously Presented) The film according to claim 1 wherein the substrate comprises polyethylene terephthalate.

9. (Previously Presented) The film according to claim 1 wherein the substrate layer is a heat-sealable layer.

10. (Previously Presented) The film according to claim 1 wherein there is disposed on the second surface of the substrate layer a heat-sealable layer.

11. (Previously Presented) The film according to claim 10 wherein the heat-sealable layer is a copolyester derived from ethylene glycol, terephthalic acid and isophthalic acid.

12. (Previously Presented) The film according to claim 10 wherein the heat-sealable layer is a copolyester derived from terephthalic acid, ethylene glycol and 1,4-cyclohexanedimethanol.

13. (Previously Presented) The film according to claim 10 wherein the heat-sealable layer is a copolyester derived from an aromatic dicarboxylic acid, an aliphatic dicarboxylic acid and a stoichiometric amount of one or more glycols, wherein the concentration of said aromatic dicarboxylic acid in the copolyester is in the range from 50 to 55 mole % based on all the dicarboxylic acid components of the copolyester, and the concentration of said aliphatic dicarboxylic acid in the copolyester is in the range from 45 to 50 mole % based on all the dicarboxylic acid components of the copolyester.

14. (Previously Presented) The film according to claim 13 wherein said aromatic dicarboxylic acid is terephthalic acid, wherein said aliphatic dicarboxylic acids are selected from sebacic acid, adipic acid and azelaic acid, and wherein the glycol component is ethylene or butylene glycol.

15. (Previously Presented) The film according to claim 10 wherein said heat-sealable layer comprises an ethylene vinyl acetate (EVA) having a vinyl acetate content in the range of 9% to 40%.

16. (Previously Presented) The film according to claim 1 wherein the venting means comprises incisions which are from about 1 to about 40 mm in length.

17. (Previously Presented) The film according to claim 16 having from 1 to 100 incisions per 200 cm².

18. (Previously Presented) The film according to claim 1 wherein the venting means comprises perforations having an average diameter from about 0.05 to about 1.5 mm.

19. (Previously Presented) The film according to claim 18 wherein the venting means comprises from about 1 to about 100,000 perforations per 200 cm².

20. (Previously Presented) The film according to claim 18 or 19 wherein the substrate has a degree of perforation of from about 0.001 to about 50%.

21. (Withdrawn) A process for producing a heat-sealable composite film comprising

- (a) providing a polymeric substrate layer having a first and second surface and optionally a discrete heat-sealable layer disposed on the second surface of the substrate;
- (b) providing one or more venting means in said substrate and if present said discrete heat-sealable layer; and
- (c) providing a water-soluble barrier layer on a surface of the substrate, wherein the thickness of the barrier layer is from about 0.05 to about 40 µm.

22. (Withdrawn) A process according to claim 21 wherein the barrier layer is coated onto the substrate.

23. (Withdrawn) An ovenable meal in a package comprising a film according to claim 1.

24. (Withdrawn) The ovenable meal according to claim 23 wherein said film allows self-venting of the of the package of said ovenable meal.

25. (Withdrawn) The package according to claim 23 further comprising a lid said lid comprising said film, said packaging further comprising a receptacle for the ovenable meal.

26. (Withdrawn) A packaged food product wherein the packaging comprises a film according to claim 1.

27. (Withdrawn) A packaged food product according to claim 26 wherein the packaging comprises a receptacle containing the food product, and a lid, said lid comprising said film.

28-29. (Cancelled)

30. (Previously Presented) The film according to claim 11 wherein the molar ratio of the terephthalic acid component to the isophthalic acid component is in the range from 65:35 to 85:15.

31. (Previously Presented) The film according to claim 11 wherein the molar ratio of the terephthalic acid component to the isophthalic acid component is about 82:18.

32. (Previously Presented) The film according to claim 12 wherein the molar ratio of 1,4-cyclohexanedimethanol to ethylene glycol is in the range from 30:70 to 35:65.

33. (Previously Presented) The film according to claim 12 wherein the molar ratio of 1,4-cyclohexanedimethanol to ethylene glycol is about 33:67.